

60V DUAL N-CANNEL ENHANCEMENT MODE MOSFET
Product Summary

| BV _{DSS} | R _{DS(ON)} | I _D T _A = +25°C |
|-------------------|-------------------------------|--|
| 60V | 66mΩ @ V _{GS} = 10V | 4.4A |
| | 97mΩ @ V _{GS} = 4.5V | 3.6A |

Description and Applications

This MOSFET is designed to minimize the on-state resistance yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

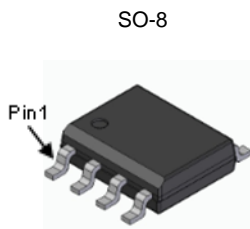
- Motor controls
- Backlighting
- DC-DC converters
- Power-management functions

Features and Benefits

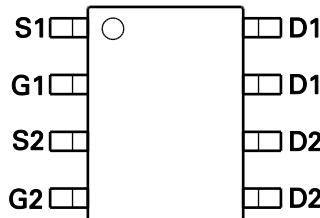
- Low On-Resistance
- Fast Switching Speed
- 100% Unclamped Inductive Switch (UIS) Test in Production
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at <https://www.diodes.com/products/automotive/automotive-products/>.**
- **This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.** <https://www.diodes.com/quality/product-definitions/>

Mechanical Data

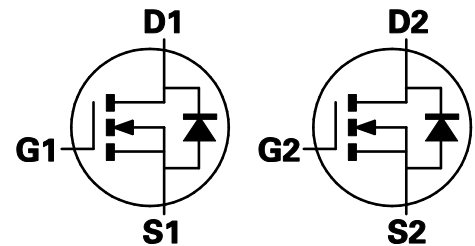
- Package: SO-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram Below
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ^(E3)
- Weight: 0.074 grams (Approximate)



Top View



Top View

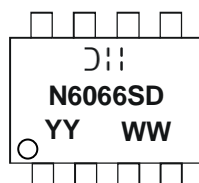


Equivalent Circuit

Ordering Information

| Orderable Part Number | Package | Packing | |
|-----------------------|---------|---------|-------------|
| | | Qty. | Carrier |
| DMN6066SSD-13 | SO-8 | 2,500 | Tape & Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information


⌋:: = Manufacturer's Marking
 N6066SD = Product Type Marking Code
 YYWW = Date Code Marking
 YY or YY = Year (ex: 24 = 2024)
 WW = Week (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

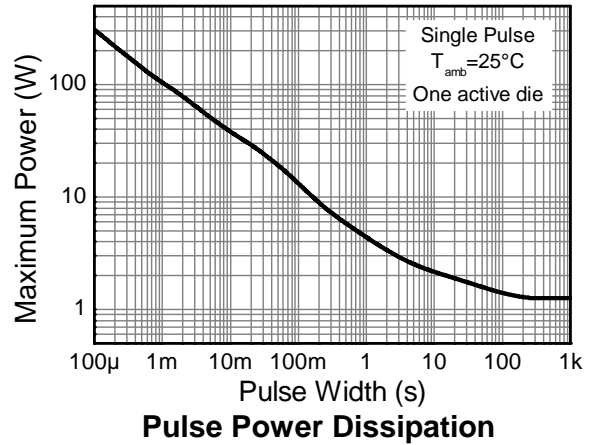
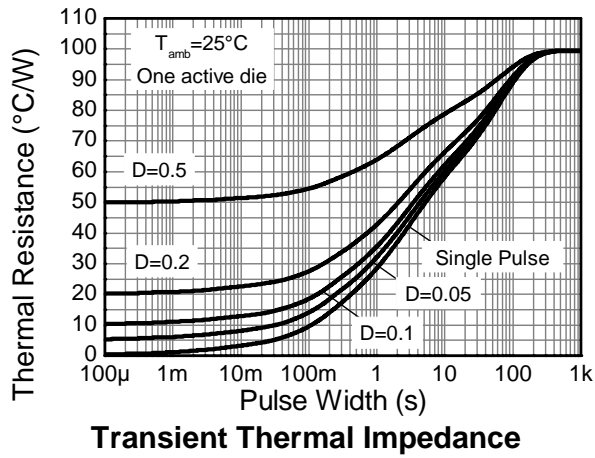
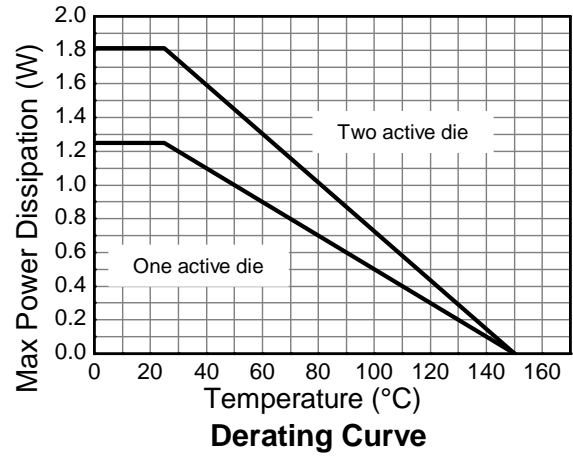
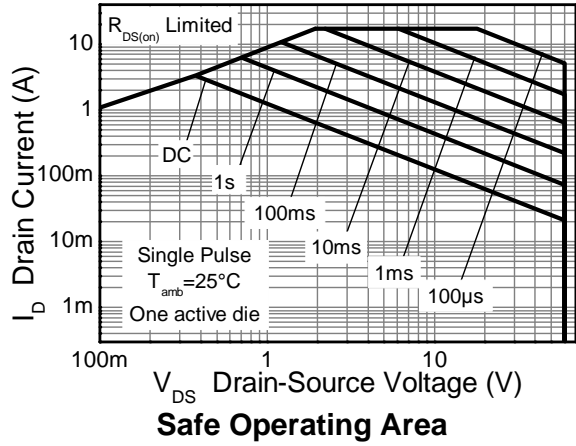
| Characteristic | | Symbol | Value | Unit |
|--|-----------------------|---------------------------------|-------|------|
| Drain-Source Voltage | | V _{DSS} | 60 | V |
| Gate-Source Voltage | (Note 5) | V _{GS} | ±20 | V |
| Single Pulsed Avalanche Energy | | E _{AS} | 37.5 | mJ |
| Single Pulsed Avalanche Current | | I _{AS} | 5.0 | A |
| Continuous Drain Current | V _{GS} = 10V | (Note 8) | 4.4 | A |
| | | T _A = +70°C (Note 8) | 3.5 | |
| | | (Note 6) | 3.3 | |
| Pulsed Drain Current | V _{GS} = 10V | I _{DM} | 17.0 | A |
| Continuous Source Current (Body Diode) | | I _S | 3.2 | A |
| Pulsed Source Current (Body Diode) | | I _{SM} | 17.0 | A |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|---|----------------|-----------------------------------|-------------|------------|
| Power Dissipation Linear Derating Factor | (Notes 6 & 9) | P _D | 1.25 | W mW/°C |
| | | | 10 | |
| | (Notes 6 & 10) | | 1.8 | |
| | | | 14.3 | |
| Thermal Resistance, Junction to Ambient | (Notes 7 & 9) | R _{θJA} | 2.14 | °C/W |
| | | | 17.2 | |
| | (Notes 6 & 9) | | 100 | |
| | (Notes 6 & 10) | | 70 | |
| Thermal Resistance, Junction to Lead | (Notes 7 & 9) | R _{θJL} | 58 | °C/W |
| | (Notes 9 & 11) | | 55 | |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to +150 | °C |

- Notes:
5. AEC-Q101 V_{GS} maximum is ±16V.
 6. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 7. Same as Note 6, except the device is measured at t ≤ 10 sec.
 8. Same as Note 6, except the device is pulsed with D = 0.02 and pulse width 300µs. The pulse current is limited by the maximum junction temperature.
 9. For a dual device with one active die.
 10. For a device with two active dies running at equal power.
 11. Thermal resistance from junction to solder-point (at the end of the drain lead).
 12. UIS in production with L = 3.0mH, I_{AS} = 5.0A, R_G = 25Ω, V_{DD} = 50V, starting T_J = +25°C.

Thermal Characteristics

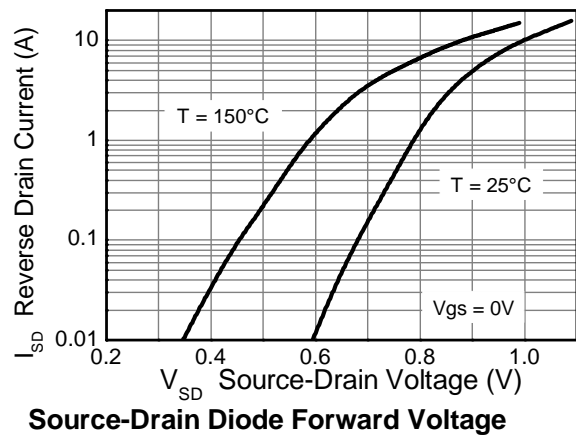
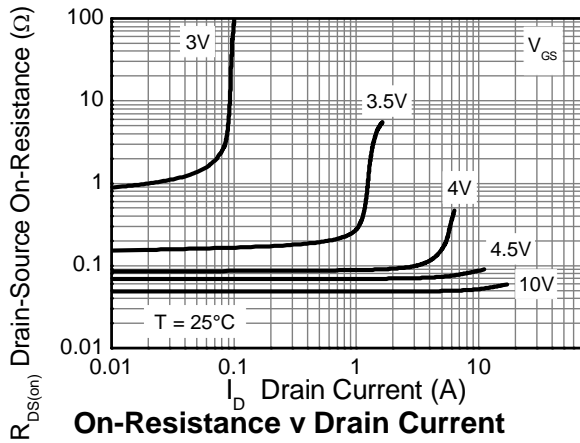
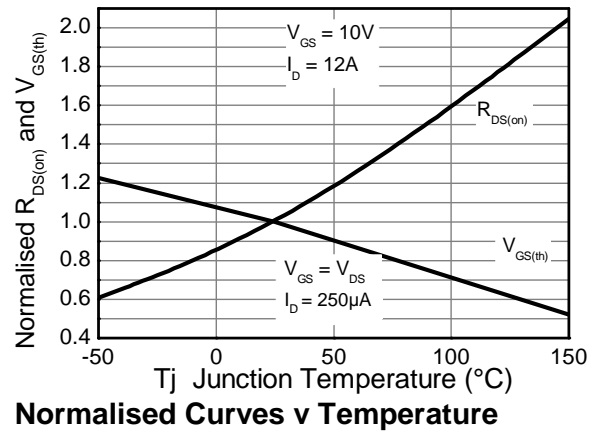
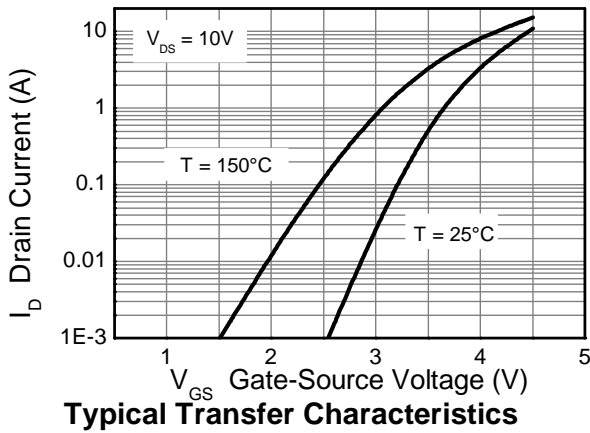
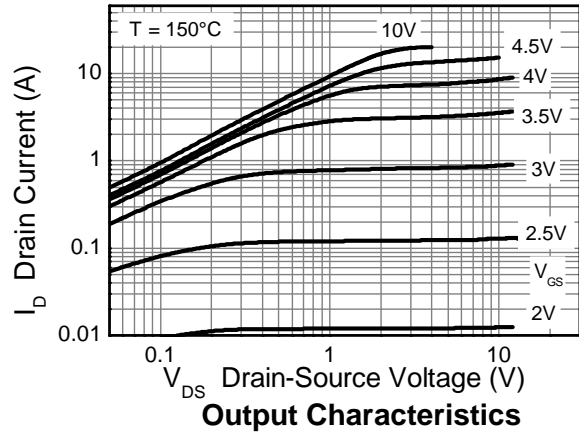
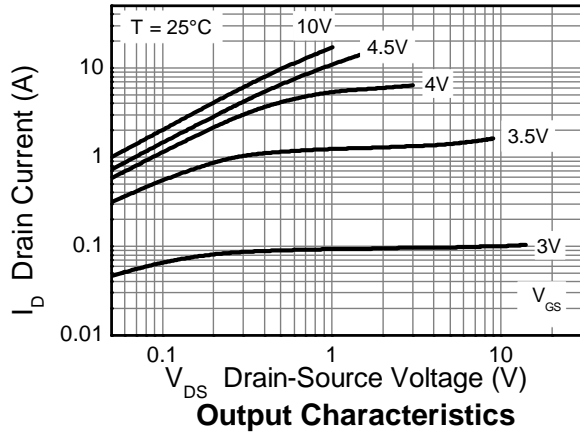


Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

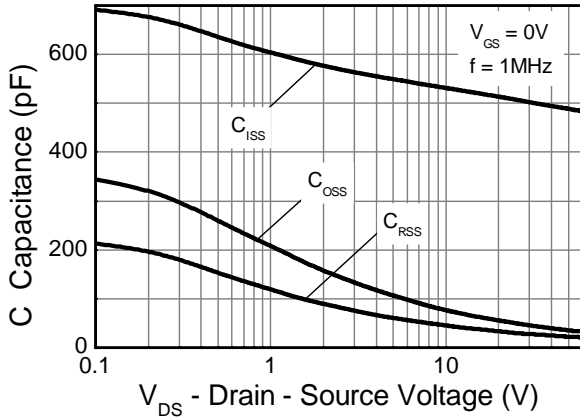
| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|---|---------------------|-----|------|------|------|--|
| OFF CHARACTERISTICS | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 60 | — | — | V | I _D = 250μA, V _{GS} = 0V |
| Zero Gate Voltage Drain Current | I _{DSS} | — | — | 0.5 | μA | V _{DS} = 60V, V _{GS} = 0V |
| Gate-Source Leakage | I _{GSS} | — | — | ±100 | nA | V _{GS} = ±20V, V _{DS} = 0V |
| ON CHARACTERISTICS | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | 1.0 | — | 3.0 | V | I _D = 250μA, V _{DS} = V _{GS} |
| Static Drain-Source On-Resistance (Note 13) | R _{DS(on)} | — | 48 | 66 | mΩ | V _{GS} = 10V, I _D = 4.5A |
| | | | 68 | 97 | | V _{GS} = 4.5V, I _D = 3.5A |
| Forward Transconductance (Notes 13 & 14) | g _{fs} | — | 19.2 | — | S | V _{DS} = 15V, I _D = 6A |
| Diode Forward Voltage (Note 13) | V _{SD} | — | 0.89 | 1.15 | V | I _S = 4.5A, V _{GS} = 0V |
| Reverse-Recovery Time (Note 14) | t _{rr} | — | 22.2 | — | ns | I _S = 1.9A, di/dt = 100A/μs |
| Reverse-Recovery Charge (Note 14) | Q _{rr} | — | 16.9 | — | nC | |
| DYNAMIC CHARACTERISTICS (Note 14) | | | | | | |
| Input Capacitance | C _{iss} | — | 502 | — | pF | V _{DS} = 30V, V _{GS} = 0V f = 1MHz |
| Output Capacitance | C _{oss} | — | 45.7 | — | pF | |
| Reverse Transfer Capacitance | C _{rss} | — | 27.1 | — | pF | |
| Total Gate Charge (Note 15) | Q _g | — | 5.4 | — | nC | V _{GS} = 4.5V |
| Total Gate Charge (Note 15) | Q _g | — | 10.3 | — | nC | V _{GS} = 10V |
| Gate-Source Charge (Note 15) | Q _{gs} | — | 1.7 | — | nC | |
| Gate-Drain Charge (Note 15) | Q _{gd} | — | 3.2 | — | nC | |
| Turn-On Delay Time (Note 15) | t _{D(on)} | — | 2.7 | — | ns | V _{DD} = 30V, V _{GS} = 10V I _D = 1A, R _G ≅ 6.0Ω |
| Turn-On Rise Time (Note 15) | t _r | — | 2.4 | — | ns | |
| Turn-Off Delay Time (Note 15) | t _{D(off)} | — | 14.7 | — | ns | |
| Turn-Off Fall Time (Note 15) | t _f | — | 5.4 | — | ns | |

- Notes:
- 13. Measured under pulsed conditions. Pulse width ≤ 300μs; duty cycle ≤ 2%.
 - 14. For design aid only, not subject to production testing.
 - 15. Switching characteristics are independent of operating junction temperatures.

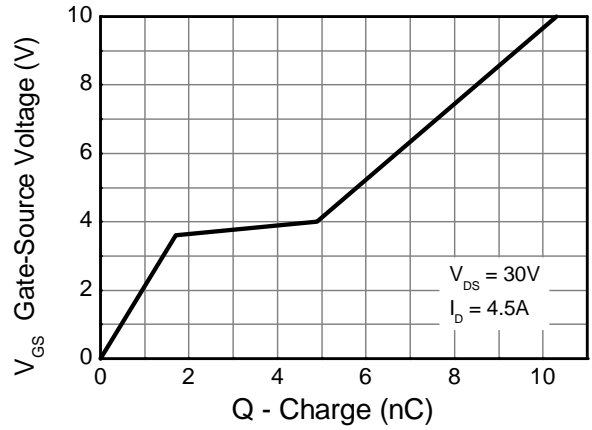
Typical Characteristics



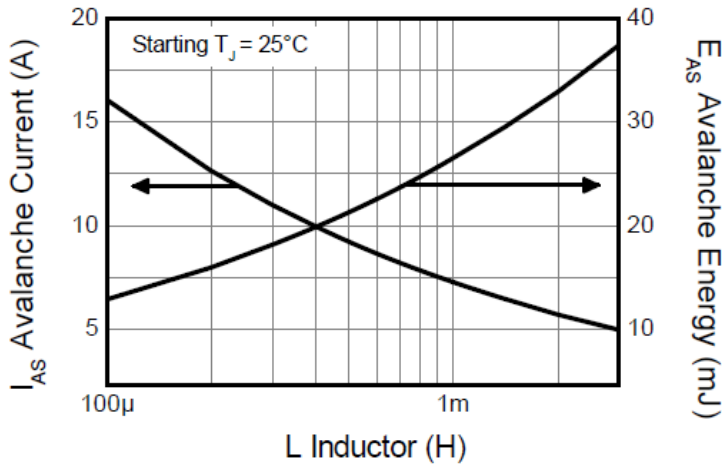
Typical Characteristics (continued)



Capacitance v Drain-Source Voltage

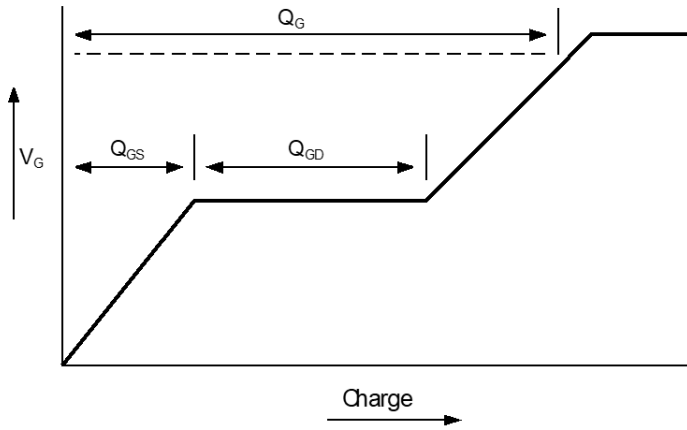


Gate-Source Voltage v Gate Charge

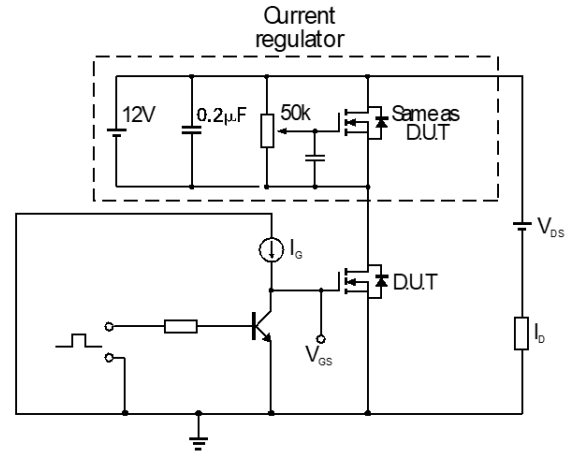


Single-Pulsed Avalanche Rating

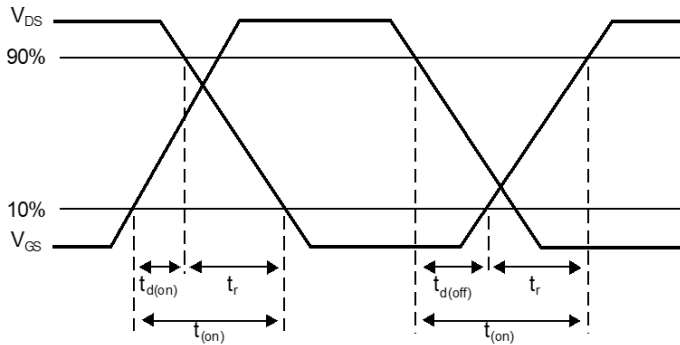
Test Circuits



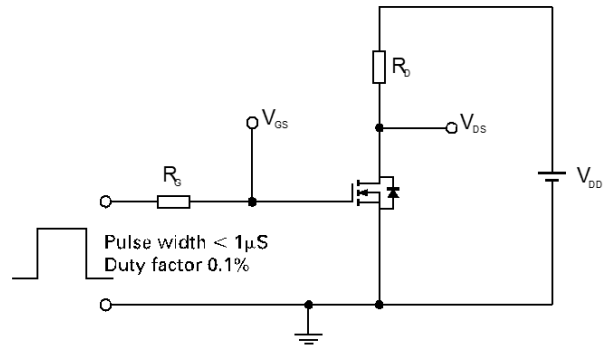
Basic gate charge waveform



Gate charge test circuit



Switching time waveforms

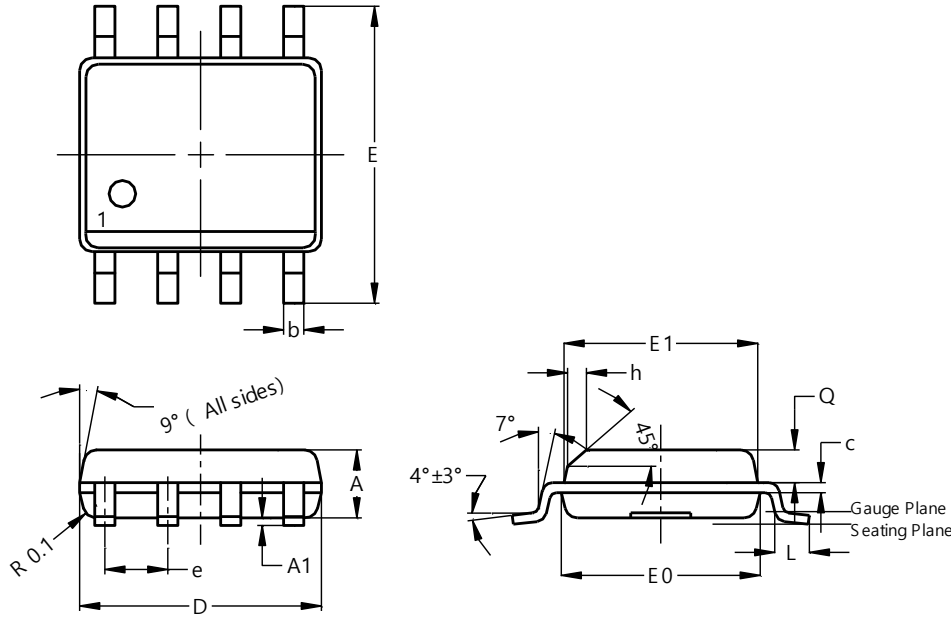


Switching time test circuit

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SO-8

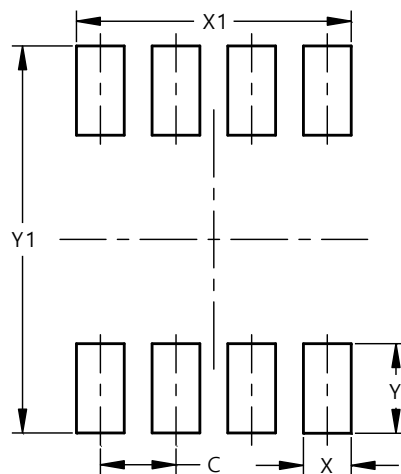


| SO-8 | | | |
|-----------------------------|------|------|------|
| Dim | Min | Max | Typ |
| A | 1.40 | 1.50 | 1.45 |
| A1 | 0.10 | 0.20 | 0.15 |
| b | 0.30 | 0.50 | 0.40 |
| c | 0.15 | 0.25 | 0.20 |
| D | 4.85 | 4.95 | 4.90 |
| E | 5.90 | 6.10 | 6.00 |
| E1 | 3.80 | 3.90 | 3.85 |
| E0 | 3.85 | 3.95 | 3.90 |
| e | -- | -- | 1.27 |
| h | -- | -- | 0.35 |
| L | 0.62 | 0.82 | 0.72 |
| Q | 0.60 | 0.70 | 0.65 |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SO-8



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 1.27 |
| X | 0.802 |
| X1 | 4.612 |
| Y | 1.505 |
| Y1 | 6.50 |

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